

N-Channel Silicon Carbide MOSFET

Rev.01 - 1 March 2024

**Product data sheet** 

alogen-Free

ead-Free

### **1. General description**

Silicon Carbide MOSFET in a TO247-4L plastic package, designed for high frequency, high efficiency systems.

## 2. Features and benefits

- Separate driver source pin
- Low on-resistance
- Fast switching speed
- 0V turn-off gate voltage for simple gate drive
- 100% UIS Tested
- Easy to parallel
- Controllable dV/dt for optimized EMI
- Reduced cooling requirements
- RoHS compliant

### 3. Applications

- Switch Mode Power Supplies
- UPS
- Battery formation instrument
- Solar string inverter and solar optimizer
- EV Charger
- Motor Drives

### 4. Quick reference data

Table 1. Qu	lick reference data						
Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute	maximum rating						
$V_{\rm DS}$	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		650			V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 18 V; T <sub>mb</sub> = 25 °C			84		А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C, T <sub>j</sub> = 175 °C		429		W	
T <sub>j</sub>	junction temperature			-55 to 175			°C
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics					·	·
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS}$ = 15 V; $I_{D}$ = 25 A; $T_{j}$ = 25 °C		-	45	58	mΩ
		V <sub>GS</sub> = 18 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C		-	33	43	mΩ
Dynamic	characteristics						
Q <sub>G(tot)</sub>	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 400 \text{ V}; V_{GS} = -4 \text{ V}/18 \text{ V};$		-	87	-	nC
$Q_{GD}$	gate-drain charge	T <sub>j</sub> = 25 °C		-	9	-	nC
Source-d	rain diode						
Q <sub>r</sub>	recovered charge	$I_{SD}$ = 25 A; di/dt = 500 A/µs; $V_{DS}$ = 400 V; $T_{j}$ = 25 °C		-	94	-	nC

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# 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	D	drian		D
2	S	source		
3	SS	source sense		
4	G	gate		SS sym301 S
mb	D	mounting base; connected to drain		,

# 6. Ordering information

Table 3. Ordering information								
	Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
	WNSC2M45065R	TO247-4L	WNSC2M45065R6Q	Tube	30	TO247N-4L	17-Dec-2021	

### 7. Marking

Table 4. Marking codes							
Type number	Marking codes						
WNSC2M45065R	WNSC2M						
	45065R						

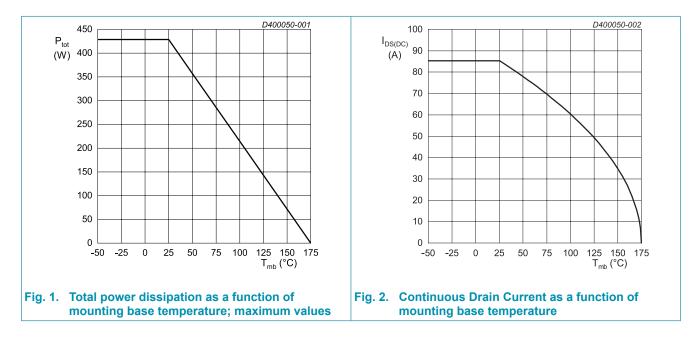
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# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		650	V
$V_{GS,max}$	gate-source voltage			-10 to 22	V
$V_{GS,op}$	gate-source voltage			-4 to 18	V
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C, T <sub>j</sub> = 175 °C		429	W
I <sub>D</sub>	drain current	V <sub>GS</sub> = 18 V; T <sub>mb</sub> = 25 °C		84	А
		V <sub>GS</sub> = 18 V; T <sub>mb</sub> = 100 °C		60	А
I <sub>DM</sub>	peak drain current	pulse width $t_p$ limited by $T_{jmax}$	Fig.17	170	А
ls	continuous diode current	V <sub>GS</sub> = -4 V; T <sub>mb</sub> = 25 °C		80	А
I <sub>SM</sub>	pulse diode current	$V_{GS}$ = -4 V; pulse width $t_p$ limited by $T_{jmax}$		170	A
E <sub>as</sub>	single pulse drain-to- source avalanche	$I_{AS} = 20 \text{ A}; \text{ L} = 1 \text{ mH}; \text{ V}_{DD} = 100 \text{ V};$ $T_j = 25 \text{ °C}$		200	mJ
T <sub>stg</sub>	storage temperature			-55 to 175	°C
T <sub>j</sub>	junction temperature			-55 to 175	°C
T <sub>sld(M)</sub>	peak soldering temperature			260	°C



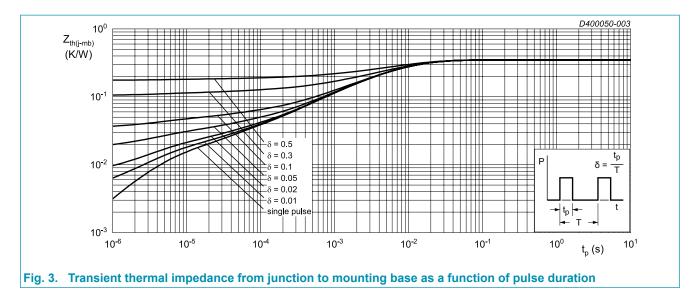
## 9. Thermal & Mechanical characteristics

#### Table 6. Thermal & Mechanical characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base			-	0.35	-	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air		-	40	-	K/W
$M_{d}$	Mounting torque	M3 or 6 - 32 screw		-	-	0.6	Nm

Note: It is recommended that a metal washer is inserted between screw head and mounting tab. Do not use self-tapping screws.

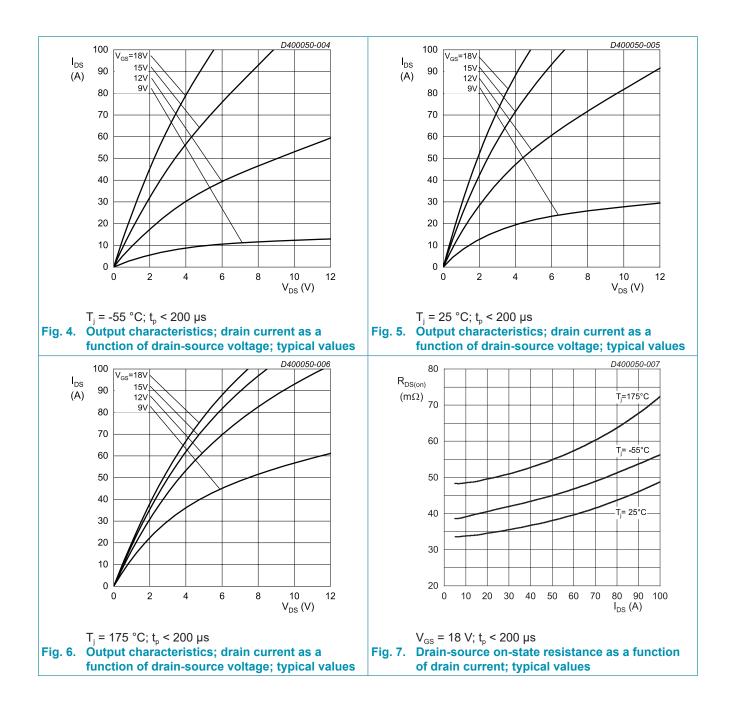
Device is ESD sensitive. Handling precautions are recommanded.

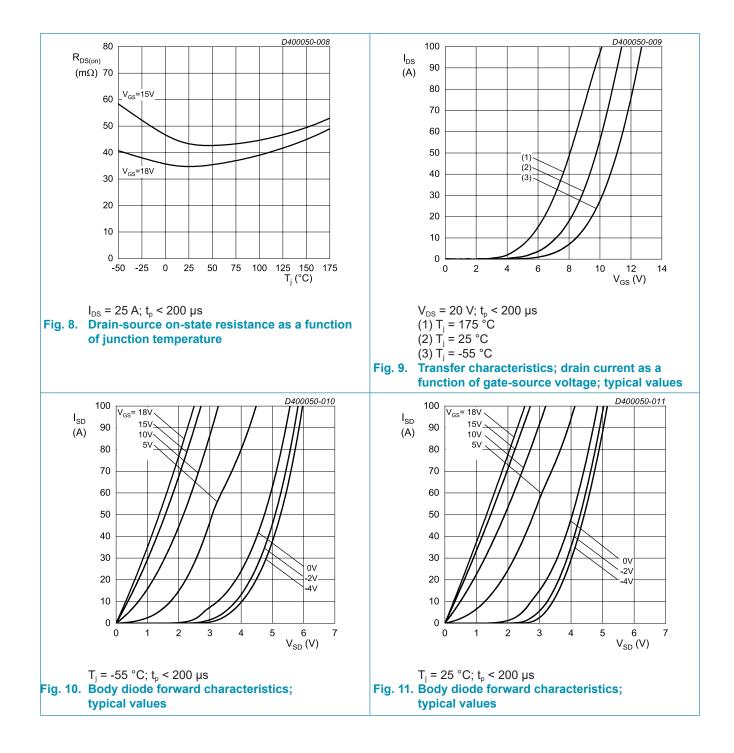


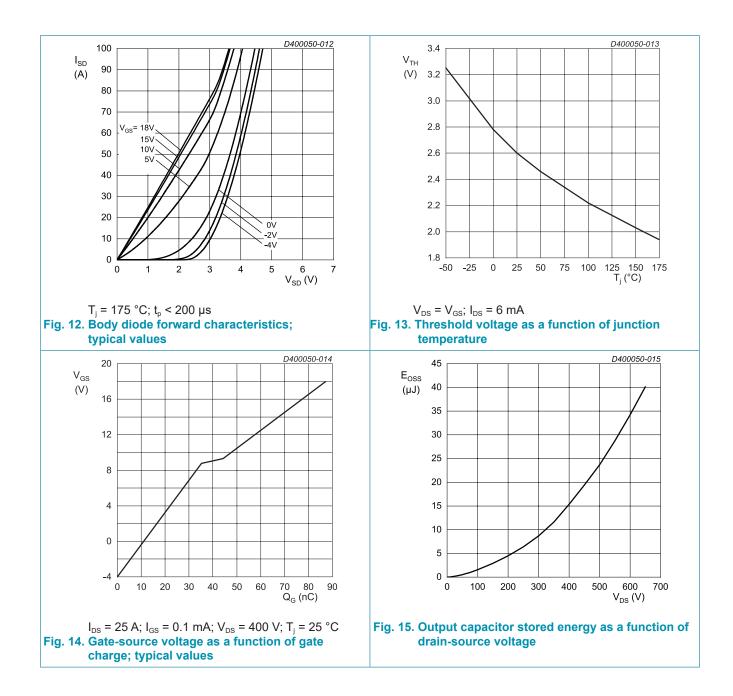
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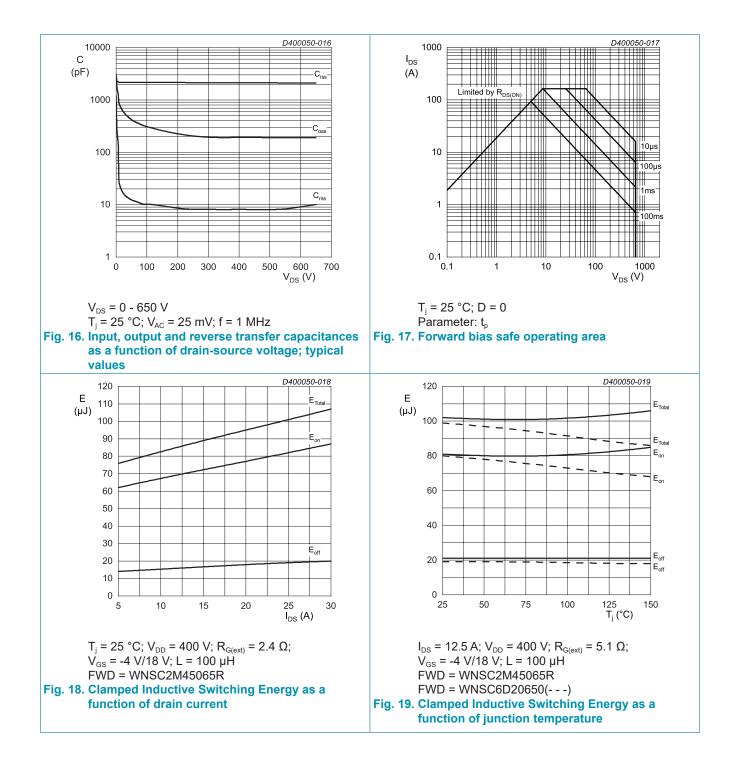
### **10. Characteristics**

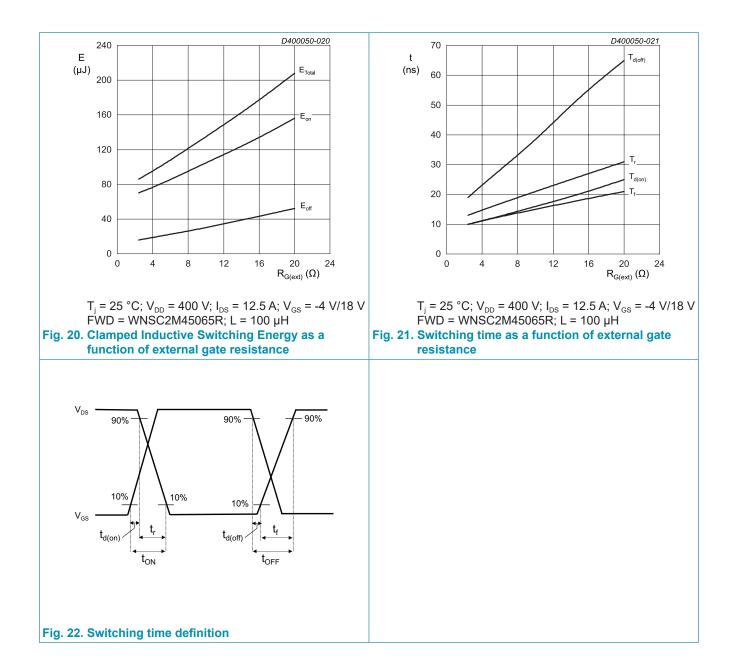
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics	1					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_{D}$ = 100 µA; $V_{GS}$ = 0 V; $T_{j}$ = 25 °C		650	-	-	V
$V_{\text{GS(th)}}$	gate-source threshold voltage	$I_{D}$ = 6 mA; $V_{DS}$ = $V_{GS}$ ; $T_{j}$ = 25 °C		1.9	2.6	3.5	V
		I <sub>D</sub> = 6 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = 175 °C		-	1.9	-	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 650 \text{ V}; V_{GS} = 0 \text{ V}; \text{T}_{j} = 25 ^{\circ}\text{C}$		-	0.1	50	μA
		$V_{DS}$ = 650 V; $V_{GS}$ = 0 V; $T_j$ = 175 °C		-	5	-	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 22 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C		-	5	100	nA
		V <sub>GS</sub> = -10 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C		-	5	100	nA
R <sub>DS(on)</sub>	drain-source on-state	V <sub>GS</sub> = 15 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C		-	45	58	mΩ
	resistance	V <sub>GS</sub> = 18 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C		-	33	43	mΩ
		V <sub>GS</sub> = 18 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 175 °C		-	49	-	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz; T <sub>j</sub> = 25 °C		-	3.1	-	Ω
<b>g</b> <sub>fs</sub>	transconductance	V <sub>DS</sub> = 20 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C		-	15	-	S
Dynamic	characteristics						
Q <sub>G(tot)</sub>	total gate charge	$I_{D}$ = 25 A; $V_{DS}$ = 400 V; $V_{GS}$ = -4 V/18 V;		-	87	-	nC
Q <sub>GS</sub>	gate-source charge	$T_j = 25 \ ^{\circ}C$		-	35	-	nC
Q <sub>GD</sub>	gate-drain charge			-	9	-	nC
C <sub>iss</sub>	input capacitance	$V_{DS} = 400 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$ $T_j = 25 \text{ °C}$		-	2167	-	pF
C <sub>oss</sub>	output capacitance			-	191	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	8	-	pF
E <sub>oss</sub>	Coss stored energy			-	95.5	-	μJ
t <sub>d(on)</sub>	turn-on delay time	$V_{\text{DS}}$ = 400 V; $V_{\text{GS}}$ = -4 V/18 V; $R_{\text{G(ext)}}$ = 5.1		-	12	-	ns
t,	rise time	Ω; I <sub>D</sub> = 12.5 A; L = 100 μH; T <sub>j</sub> = 25 °C		-	16	-	ns
t <sub>d(off)</sub>	turn-off delay time			-	26	-	ns
t <sub>f</sub>	fall time			-	12	-	ns
Eon	turn-on energy (SiC Diode FWD)		Fig.19	-	80	-	μJ
E <sub>off</sub>	turn-off energy (SiC Diode FWD)		Fig.19	-	19	-	μJ
E <sub>on</sub>	turn-on energy (Body Diode FWD)		Fig.19	-	81	-	μJ
E <sub>off</sub>	turn-off energy (Body Diode FWD)		Fig.19	-	21	-	μJ
Source-d	rain diode	1	I	L		J	
V <sub>SD</sub>	source-drain voltage	V <sub>GS</sub> = 0 V; I <sub>SD</sub> = 25 A; T <sub>j</sub> = 25 °C		-	3.4	-	V
		V <sub>GS</sub> = -4 V; I <sub>SD</sub> = 25 A; T <sub>j</sub> = 25 °C		-	3.9	-	V
		V <sub>GS</sub> = -4 V; I <sub>SD</sub> = 25 A; T <sub>j</sub> = 175 °C		-	3.4	-	V
t <sub>rr</sub>	reverse recovery time	I <sub>SD</sub> = 25 A; di/dt = 500 A/μs; V <sub>DS</sub> = 400 V;		-	32	-	ns
Q <sub>r</sub>	recovered charge	$T_j = 25 \ ^{\circ}C$		-	94	-	nC
I <sub>rrm</sub>	reverse recovery current			-	5.9	_	Α





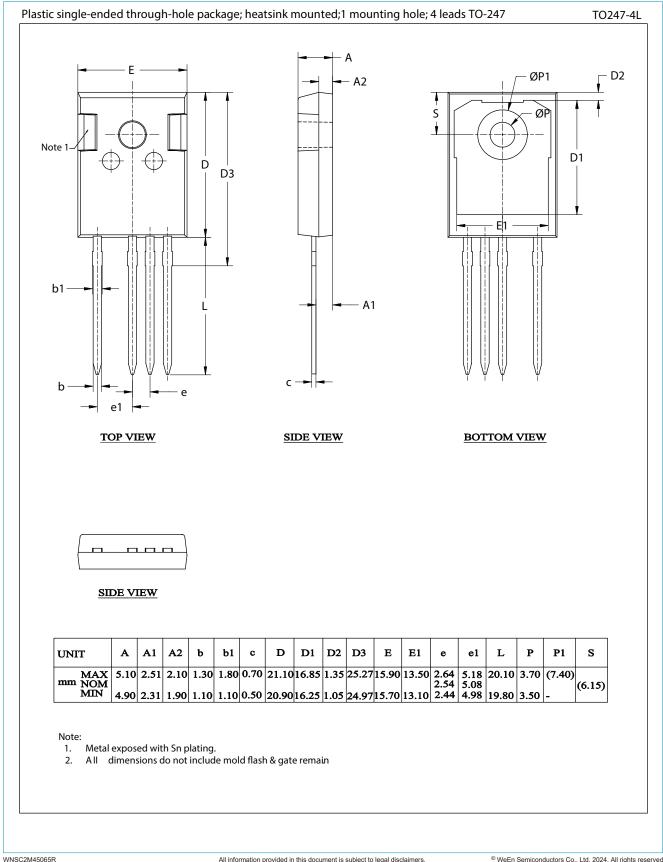






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### 11. Package outline



#### **N-Channel Silicon Carbide MOSFET**

# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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